

3.0mmx1.0mm RIGHT ANGLE SMD CHIP LED **LAMP**

Part Number: APBA3010EYC-GX

High Efficiency Red

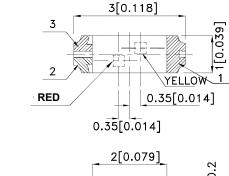
Features

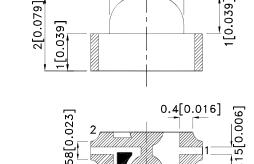
- 3.0mmx2.0mmx1.0mm right angle SMD LED, 1.0mm thickness.
- Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Package: 2000 pcs / reel.
- Moisture sensitivity level : level 3.
- Tinned pads for improved solderability
- RoHS compliant.

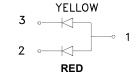
Descriptions

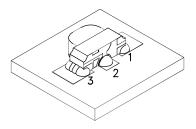
- The High Efficiency Red source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Orange Light Emitting Diode.
- The Yellow source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Yellow Light Emitting Diode.

Package Dimensions









Notes:

- All dimensions are in millimeters (inches).
 Tolerance is ±0.15(0.006") unless otherwise noted.

POLARITY MARK

3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice 4. The device has a single mounting surface. The device must be mounted according to the specifications.

0.9[0.035]

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Selection Guide

Part No.	Emitting Color (Material)	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
APBA3010EYC-GX	High Efficiency Red (GaAsP/GaP)	- Water Clear	8	15	140°
			*3	*8	
	Yellow (GaAsP/GaP)		5	8	
			*5	*8	

- 1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- Luminous intensity / luminous Flux: +/-15%.
 Luminous intensity value is traceable to CIE127-2007 standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Emitting Color	Тур.	Max.	Units	Test Conditions	
λpeak	Peak Wavelength	High Efficiency Red Yellow	627 590		nm	IF=20mA	
λD [1]	Dominant Wavelength	High Efficiency Red Yellow	617 588		nm	IF=20mA	
Δλ1/2	Spectral Line Half-width	High Efficiency Red Yellow	45 35		nm	IF=20mA	
С	Capacitance	High Efficiency Red Yellow	15 20		pF	VF=0V;f=1MHz	
VF [2]	Forward Voltage	High Efficiency Red Yellow	2 2.1	2.5 2.5	V	Ir=20mA	
lr	Reverse Current	High Efficiency Red Yellow		10 10	uA	V _R = 5V	

Notes:

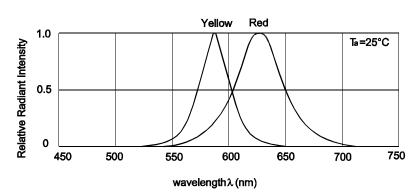
- 1. Wavelength: +/-1nm.
- 2. Forward Voltage: +/-0.1V.
- 3. Wavelength value is traceable to CIE127-2007 standards.
- 4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

Absolute Maximum Ratings at TA=25°C

Parameter	High Efficiency Red	Yellow	Units		
Power dissipation	75	75	mW		
DC Forward Current	30	30	mA		
Peak Forward Current [1]	160	140	mA		
Reverse Voltage		V			
Operating Temperature	-40°C To +85°C				
Storage Temperature	-40°C To +85°C				

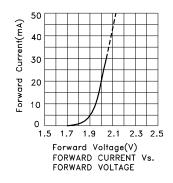
- 1. 1/10 Duty Cycle, 0.1ms Pulse Width.
 2. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity - Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

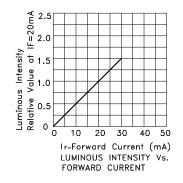
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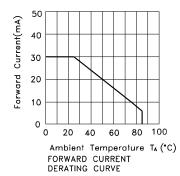


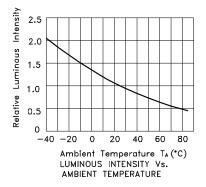
Relative Intensity Vs. Wavelength

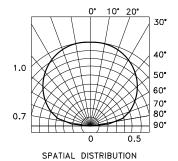
APBA3010EYC-GX High Efficiency Red





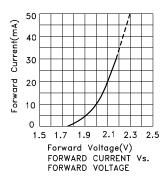


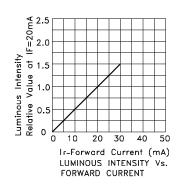


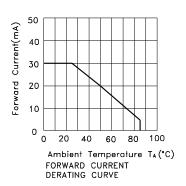


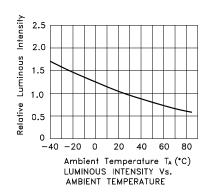
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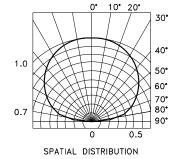
Yellow









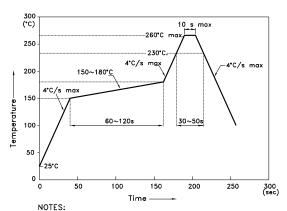


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Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



- NOTES:

 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

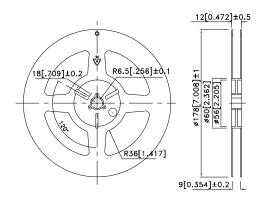
 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

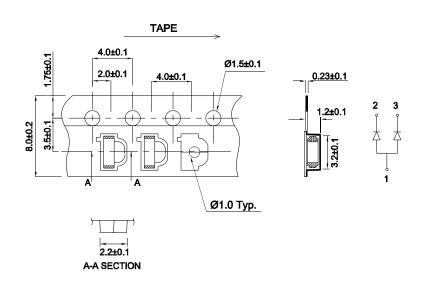
 3.Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)

Tape Dimensions (Units: mm)

Reel Dimension





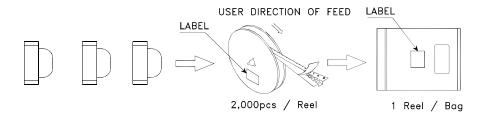
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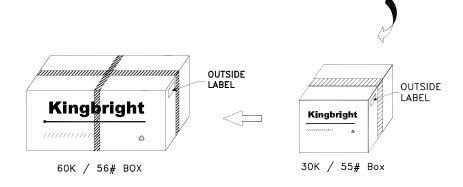
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PACKING & LABEL SPECIFICATIONS

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